

承认书

Approved Sheet

客户名称：	
客户物料名称：	
客户物料编码：	
文件编号：	
拓展品名：	TZ-C0603-WL/A-BA06KF-YA1102NA/W329
拓展料号：	W329-10452-LC

客户

拓展

检测员：
审核：
批准：
盖章：

检测员：
审核：
批准：
日期：

广东拓展光电子有限公司

BRIGHTWAY Optoelectronics Co., Ltd.

TZ-C0603-WL/A-BA06KF-YA1102NA/W329

The 0603 white LED bead (dimensions 1.6mm × 0.8mm), a miniature surface-mount device (SMD) light source, has emerged as an irreplaceable component in consumer electronics, smart hardware, and precision instruments. Its core advantages—ultra-small size, low power consumption, high brightness, and high integration—enable it to thrive in high-density, space-constrained designs, while the versatility of white light further expands its application scenarios. This article explores how this tiny component delivers exceptional value across diverse industries.



Applications/产品应用

Indicatorlight

发光指示灯

Lighting

照明

Backlight

背光

Others

其他

Features/特性

Size(mm): 1.6*0.8*0.6

尺寸 (毫米) : 1.6*0.8*0.6

Color : (Cool White)

发光颜色 : (冷白)

Thermal resistance: 20°C/W

热阻 : 20°C/W

Viewing angle: 120°

发光角度 : 120°

ESD protection up to 2 KV

抗静电 : 2kV

High reliability

高可靠性

RoHS compliant

通过RoHS认证

Absolute maximum ratings($T_a=25^{\circ}\text{C}$)/最大额定值

Parameters/参数	Symbol/符号	Value/数值	Unit/单位
Power dissipated 功率消耗	P_D	60	mW
forward current 正向电流	I_F	15	mA
Peak Forward Current 峰值正向电流	I_{FP}	100	mA
Operating temperature 工作温度	T_{OPR}	-40~+85	$^{\circ}\text{C}$
Storage temperature 储存温度	T_{STG}	-40~+85	$^{\circ}\text{C}$
Soldering temperature 焊接温度	Reflow soldering $250\pm 5^{\circ}\text{C}$ for 10sec		

Proper current derating must be observed to maintain junction temperature below the Maximum.

Electro optical characteristics($T_a=25^{\circ}\text{C}$)/光电特性

Parameters 参数	Test condition 测试条件	Symbol 符号	Min 最小	Typ 典型	Max 最大	Unit 单位
Forward voltage 正向电压	2mA	VF	2.6	--	2.9	V
View Angle 发光角度	2mA	$2\theta_{1/2}$	--	120	--	deg.
Electrostatic discharge 防静电	HBM	ESD	2000	--	--	V
Thermal resistance 热阻	2mA	RJ-A	--	--	20	$^{\circ}\text{C}/\text{W}$
Reverse current 反向电流	VR=8V	IR	--	--	5	μA

Notes:

Measurement tolerance: $V_f \pm 0.1\text{V}$ Luminous Intensity: $\pm 10\%$ Wavelength(x,y): $\pm 1\text{nm}/\pm 0.01$.

Electro optical chart(Ta=25°C)/光电特性

Color	Series Number 产品系列号	Part Number 产品型号	Forward voltage 正向电压 (V)	Color Coordinates 色坐标	Luminous intensity 光强 (mcd)
W	0603	TZ-C0603-WL/A-BA06KF-YA1102NA/W329	2.6-2.9	X:0.2840 Y:0.2810	120-210

Ranks(sorting current=2mA, Ta=25°C)/档位

Item 项目	Color 颜色	Min 最小值	Max 最大值	Unit 单位
IV光强	W	120	150	mcd
		150	180	
		180	210	

Item 项目	Color 颜色	Min 最小值	Max 最大值	Unit 单位
VF电压	W	2.6	2.7	V
		2.7	2.8	
		2.8	2.9	

Typical electrical optical characteristic curves/典型光电特征曲线

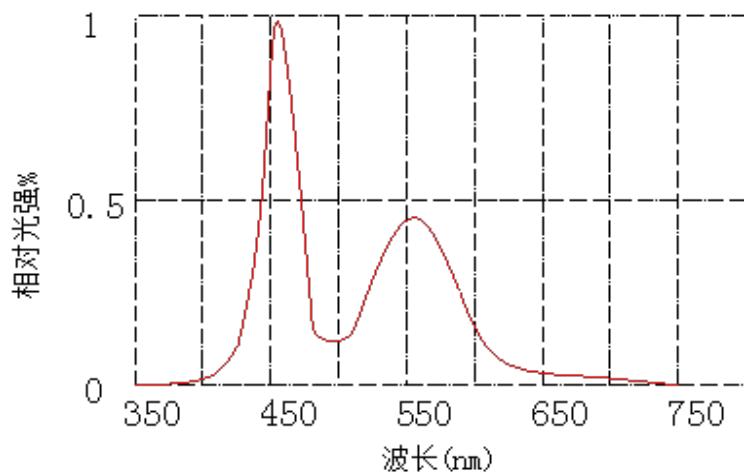


图.1 相对光强与波长曲线

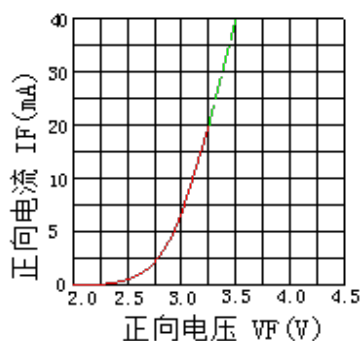


图.2 正向电压与电流曲线

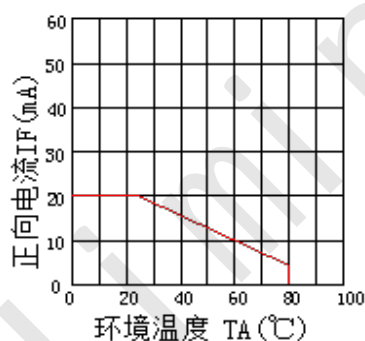


图.3 正向电流与温度曲线

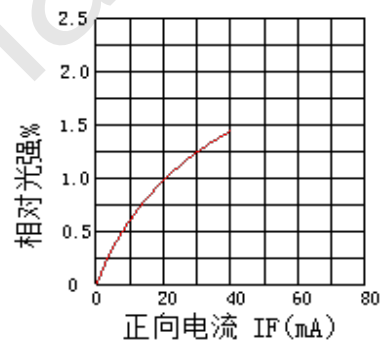


图.4 正向电流与相对光强曲线

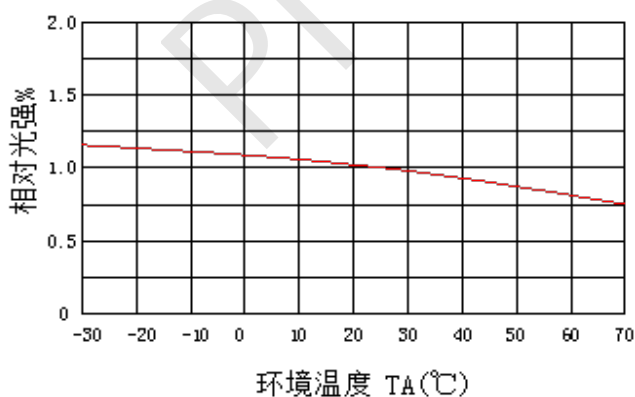


图.5 相对光强与温度曲线

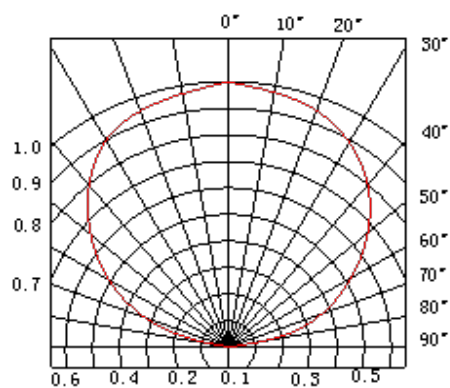
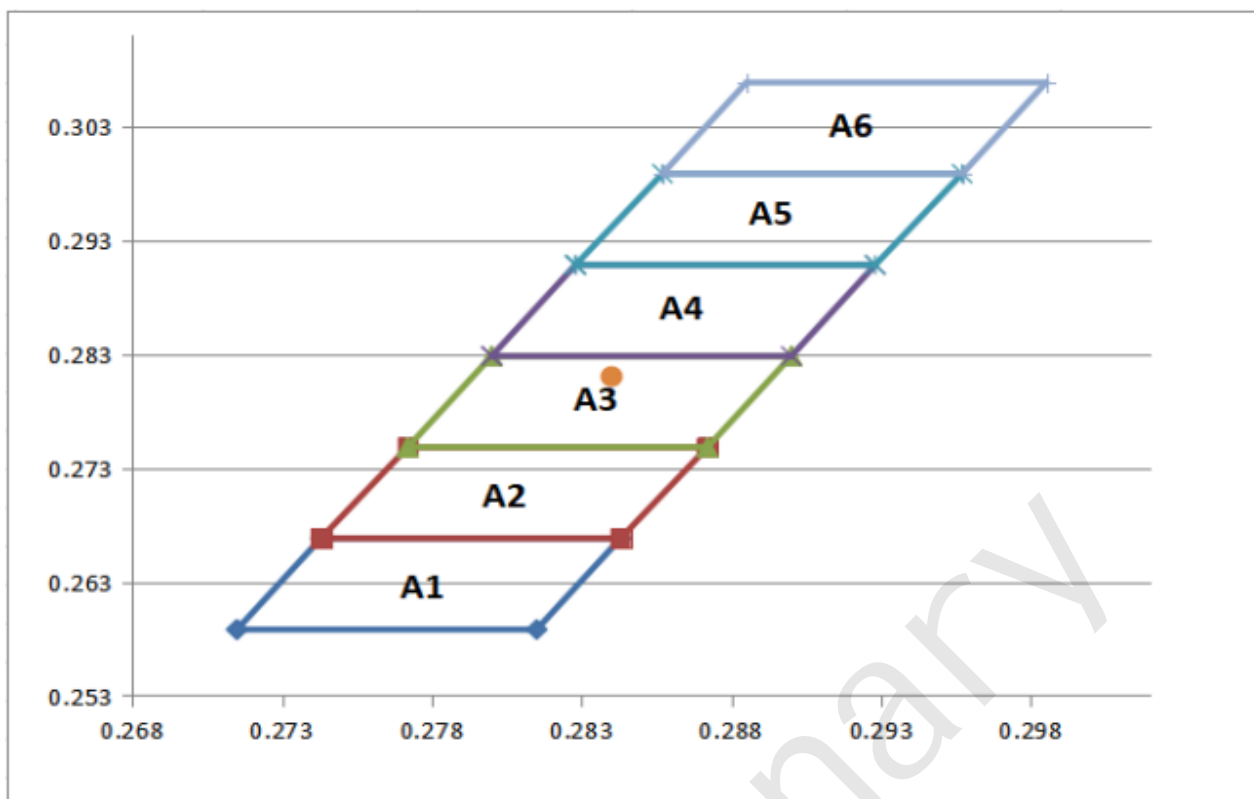


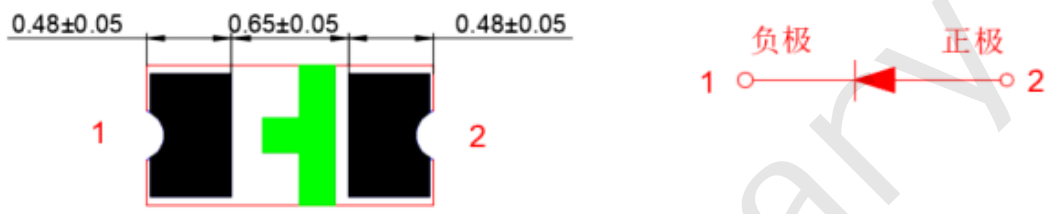
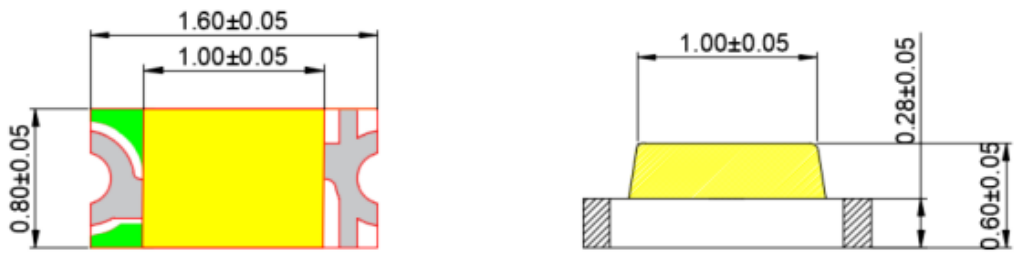
图.6 辐射特性曲线

XY Grade /XY等级

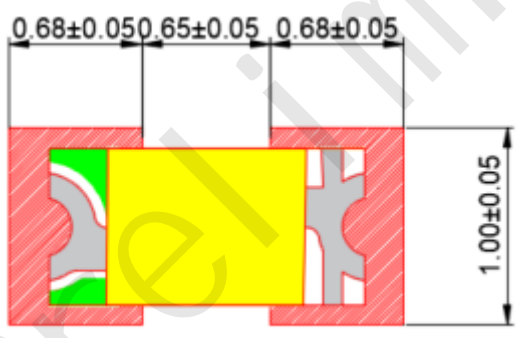


	X1Y1	X2Y2	X3Y3	X4Y4	X1Y1
A1	0.2715	0.2743	0.2843	0.2815	0.2715
	0.2588	0.2668	0.2668	0.2588	0.2588
A2	0.2743	0.2772	0.2872	0.2843	0.2743
	0.2668	0.2748	0.2748	0.2668	0.2668
A3	0.2772	0.28	0.29	0.2872	0.2772
	0.2748	0.2828	0.2828	0.2748	0.2748
A4	0.28	0.2828	0.2928	0.29	0.28
	0.2828	0.2908	0.2908	0.2828	0.2828
A5	0.2828	0.2857	0.2957	0.2928	0.2828
	0.2908	0.2988	0.2988	0.2908	0.2908
A6	0.2857	0.2885	0.2985	0.2957	0.2857
	0.2988	0.3068	0.3068	0.2988	0.2988

Package dimensions/产品外观尺寸



Recommended Pad Size/推荐焊盘尺寸：



- (1) All dimensions are in millimeters ;
单位：毫米
- (2) Tolerances are ±0.2mm unless otherwise noted.
未标注公差处公差为±0.2mm。

Packaging Specifications/包装规格

Product Labeling/产品标签

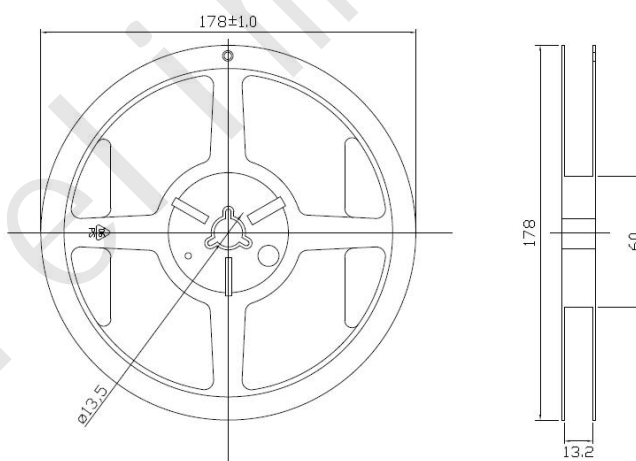
Label Explanation/标签解释

Name: Part Number
LOT No: Lot Number
Prd No: LProduct Code
IF(mA):Operation Forward current
VF(V):Forward voltage Bin
CCT: Color temperature
BIN CODE:Bin Code
QTY (pcs): Package Quantity
Date:Packaging Date



Emitter Reel Packaging/卷盘包装

Reel Dimensions/卷盘尺寸



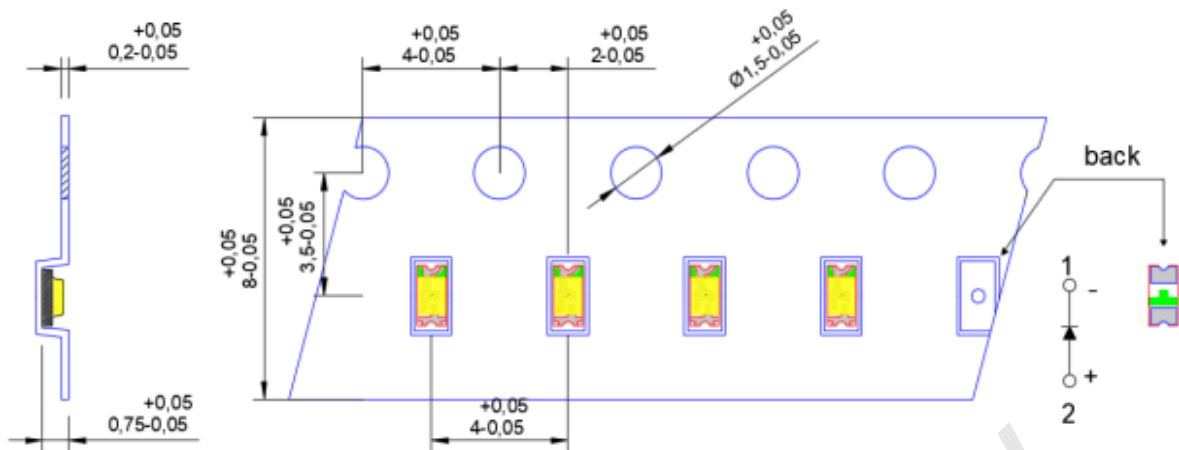
Note/备注:

1. All dimensions are in millimeters ;

单位：毫米

Tape On Reel Package/载带包装

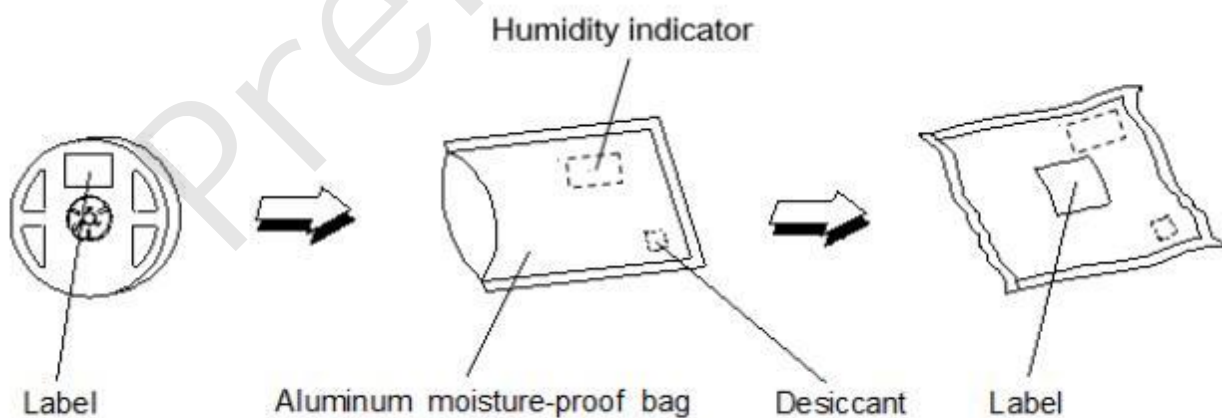
Carrier Tape Dimensions as the following/载带尺寸



Note/备注：

- (1) The cathode is oriented towards the tape sprocket hole in accordance with data sheet specifications.
根据图表显示，负极朝向载带孔。
- (2) MPQ:4000pcs per reel.
4000颗/每盘。

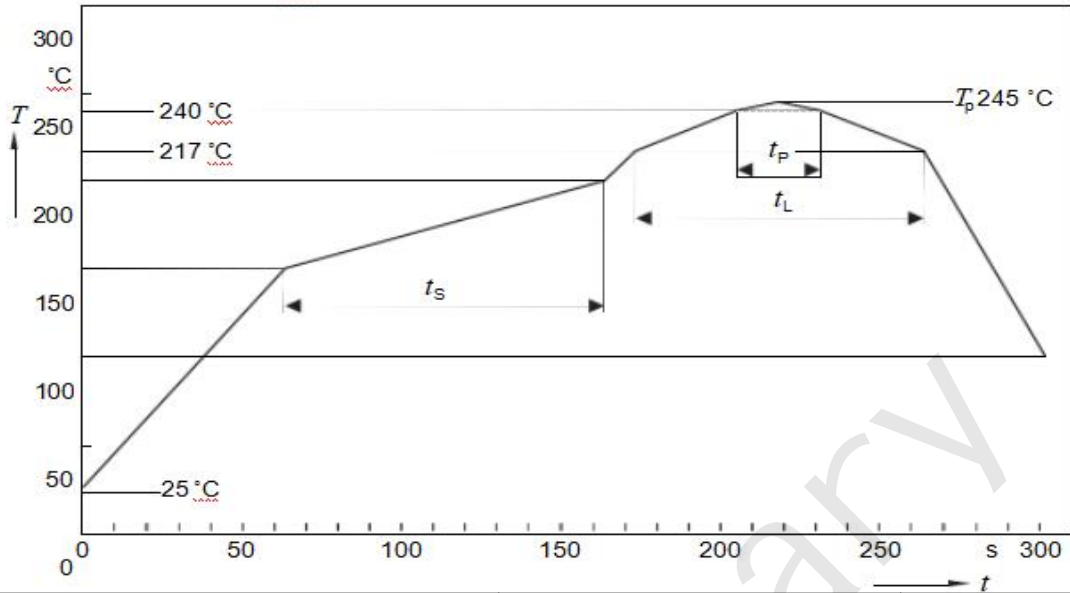
Moisture Resistant Packaging/防潮包装



Soldering Characteristics/焊接工艺

Reflow Soldering Profile/回流曲线

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Pb-Free Assembly	Unit Einheit
Average Ramp-up Rate 25 °C to 150 °C	2-3	°C /sec
Preheat Temperature Min.	150	sec
Preheat Temperature Max.	200	sec
Preheat Time	60- 120	sec
Time Maintained Above Temperature	217	°C
Time Maintained Above Time	60-90	sec
Peak Temperature (max.)	260	°C

- c. Reflow soldering should not be done more than twice.
- d. In soldering process, stress on the LEDs during heating should be avoided.
- e. After soldering, do not bend the circuit board.

Cautions/注意事项

1. Moisture-Proof Package/防潮包装

1.1 When moisture is absorbed into the LED package it may vaporize and expand products during soldering. There is a possibility that this may cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture-proof package is used to keep moisture to a minimum in the package.

当水分被吸收到 LED 包装中时，它可能会在焊接过程中蒸发并膨胀产品。这可能会导致触点脱落并损坏 LED 的光学特性。因此，防潮包装需要将包装中的水分保持在最低限度。

2. Current limiting/限流

2.1 A resistor should be used to limit current spikes that can be caused by voltage fluctuations. Otherwise damage could be occur.

应使用电阻器限制电压波动引起的电流峰值。否则可能会发生损坏。

3. Iron Soldering/烙铁焊接

3.1 Hand soldering is not recommended for regular production. These guidelines are for rework only. 常规生产不建议手工焊接。此方法仅适用于返工。

3.2 The recommended condition is less than 5s at 260°C.

建议的条件是在 260°C 时小于 5s。

3.3 The time must be shorter for higher temperatures. (+10°C→-1sec)

对于较高的温度，时间必须更短。(+10°C→-1 秒)

3.4 The power dissipation of the soldering iron should be lower than 25W and the surface temperature of the device should be controlled at under 300°C.

烙铁的功耗应低于 25W，器件表面温度应控制在 300°C 以下。

4. Storage Conditions/储存条件

4.1 Before opening the package : The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture-proof packaging with moisture-absorbent material is recommended.

打开包装前：LED 应保持在 30°C 或以下，相对湿度为 90% 或以下。LED 应在一年内使用。储存 LED 时，建议使用吸湿材进行防潮包装。

4.2 After opening the package: The LEDs should be kept at 30°C or less and 60%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, they should be stored in moisture-proof packages, such as sealed containers with packages of moisture-absorbent material. It is also recommended to return the LEDs to the original moisture-proof bag and to reseal the moisture-proof bag again.

打开包装后：LED 应保持在 30°C 或以下，相对湿度为 60% 或以下。LED 应在打开包装后 168 小时 (7 天) 内焊接。如果仍有未使用的 LED 灯珠，则应将其储存在防潮包装中，例如带有吸湿材料包装的密封

容器中。也建议将 LED 灯珠放回原来的防潮袋，并再次重新密封防潮袋。

4.3 If the moisture-absorbent material has faded away or the LEDs have exceeded the recommended storage time, baking treatment should be performed using the following conditions. Baking treatment: more than 24 hours at $65\pm 5^{\circ}\text{C}$

如果吸湿材料褪色或 LED 超过建议的存储时间，则应使用以下条件进行除湿处理。除湿处理：在 $65\pm 5^{\circ}\text{C}$ 下烘烤超过 24 小时。

4.4 **BRIGHTWAY** LED electrode sections are comprised of a silver-plated copper alloy. The silver surface may be affected by environments which contain corrosive gases and so on. Please avoid condition which may cause difficulty environments during soldering operations. It is recommended that the user uses the LEDs as soon as possible.

拓展 LED 灯珠电极部分由镀银铜合金组成。银表面可能受到含有腐蚀性气体等环境的影响。在焊接操作过程中，避免出现可能由环境导致问题的情况。建议用户尽快使用 LED 灯珠。

4.5 Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

请避免环境温度快速变化，尤其是在可能发生冷凝的高湿度环境中。

5. Handling of Silicone LEDs/硅胶 LED 灯珠处理

5.1 Avoid silicone resin parts especially with sharp tools such as tweezers.

避免使用锋利工具，尤其是使用镊子等接触硅胶部分。

5.2 Avoid leaving fingerprints on silicone part.

避免在硅胶零件上留下指纹。

6. Usage/用途

6.1 Do not exceed the values given in this specification.

不要超出本规范中给出的使用条件。